

806—825 MHz, 35-WATT POWER AMPLIFIER ASSEMBLY 19D424356G1, G5  
806—825 MHz, 25-WATT POWER AMPLIFIER ASSEMBLY 19D424356G3, G6

## TABLE OF CONTENTS

DESCRIPTION .....	Page
DESCRIPTION .....	1
CIRCUIT ANALYSIS .....	1
OUTLINE DIAGRAM .....	4
SCHEMATIC DIAGRAM .....	5
PARTS LIST AND PRODUCTION CHANGES .....	6

## DESCRIPTION

The power amplifier assembly uses six RF power transistors to provide a maximum of 35 Watts output power (Mobile) or 25 Watts output power (Station), R24, located on the PA module, is used to adjust the output power to any level from 10 Watts to rated RF power output. The power control circuit consists of R24, Q207, Power Control IC (U1), and a directional coupler.

## SUPPLY VOLTAGE AND METERING

Supply voltage is connected through power leads from the system board to feed-through capacitor C219. C219 and C220 prevent RF from getting on the power leads. Diode CR201 will cause the main fuse assembly to blow if the polarity of the power leads is reversed, providing reverse voltage protection for the PA.

Centralized metering jack J205 is provided for use with GE Test Model 4EX3A11 or Test Kit 4EX8K12. The test set meters the AMPL-1 DRIVE (exciter output), the POWER CONTROL voltage, and the DRIVER AND PA CURRENT.

## CIRCUIT ANALYSIS

## PA ASSEMBLY

The exciter output is coupled through a 50 ohm RF cable to the PA input connector P101. The RF input is coupled through a matching network composed of C2, C3, L1, L2 and L3 to the base of power amplifier Q201.

Part of the RF input is rectified by CR1 and metered at J205-4 through resistor R21. The rectified RF is also applied to the power control IC (U1).

Collector voltage to Q201 is applied from the power controller through collector stabilizing network L5 and R4 and collector feed network L4 and C201.

The output of Q201 is coupled to the base of the second power amplifier Q202 through coupling capacitor C5, and a matching network consisting of C6, C7, L6 and L7.

Collector voltage to Q202 is controlled by power control IC (U1), and Q207 and is applied through a collector stabilizing network L11 and R7 and collector feed network C202 and L10.

The output of Q202 is coupled to the base of power amplifier Q203 through C9 and the matching network of C203, C204, C10, L13, L14 and L15.

The collector voltage to Q203 is coupled directly from the supply voltage through collector stabilizing network L17 and R9 and collector feed network L16 and C11.

The output of Q203 is coupled through an impedance matching network (C206, C13, C207, C208, L18, L19, L20 and L21) and a 50 ohm microstrip W4 that matches the output impedance of Q203 to the input impedance of driver Q204.

The collector voltage of Q204 is coupled through R26 from the supply voltage, through collector stabilizing network L23 and R11, through collector feed network L22 and C15.

Collector current for Q204 is metered across tapped manganin resistor R26. The reading, taken in position "F" on the 10-Volt scale of the Test Set with the High Sensitivity button pressed, should be approximately 2.1 Amperes.

**WARNING**

The RF Power Transistors used in the transmitter contain Beryllium Oxide, a TOXIC substance. If the ceramic, or other encapsulation is opened, crushed, broken or abraded, the dust may be hazardous if inhaled. Be extremely careful to avoid damaging transistors when working with the PA assembly.

The output of Q204 is coupled through an impedance matching network (C209, C210, C16 and L24) and a 50 ohm microstrip, W5, to a power splitter consisting of microstrip transmission line W6-W9 and R12.

RF output power from Q204 (approximately 12 Watts) is split evenly between two identical class C power amplifiers Q205 and Q206 via their respective identical impedance matching networks. The impedance matching networks consist of C19, C211, C213, L27, L25, and C20, C212, C214, L26 and L27.

Collector voltage for Q205 and Q206 is supplied from the A+ line at J203-1 through identical collector stabilizing networks consisting of R13, L31, and C23, and L32, R14 and C24 respectively.

Collector current for Q205 and Q206 is metered across tapped manganin resistor R27. The reading taken in position G on the 10 Volt scale with the HIGH SENS button on the test set pressed. The meter reading should be 7.9 Amperes.

The output of Q205 and Q206 is coupled through identical impedance matching and RF power combining networks. The RF power combiner consists of microstrip transmission lines W12 and W13 and resistor 15. The combiner adds the outputs of Q205 and Q206 and applies the combined RF output to the low pass filter through 50 ohm microstrip W14.

The RF power output is applied to antenna connector J202 through 50 ohm microstrip W1 in the low pass filter, to the antenna relay in control station and to J202 in mobile PA.

**CAUTION**

The placement of monolithic capacitors on the PA board is very critical; therefore, it is not recommended that the PA board be serviced in the field.

**POWER CONTROL CIRCUIT**

The Power Control Circuit, consists of CR1, U1, Q207 and the directional coupler (C30, C31, CR3, R16 and W15).

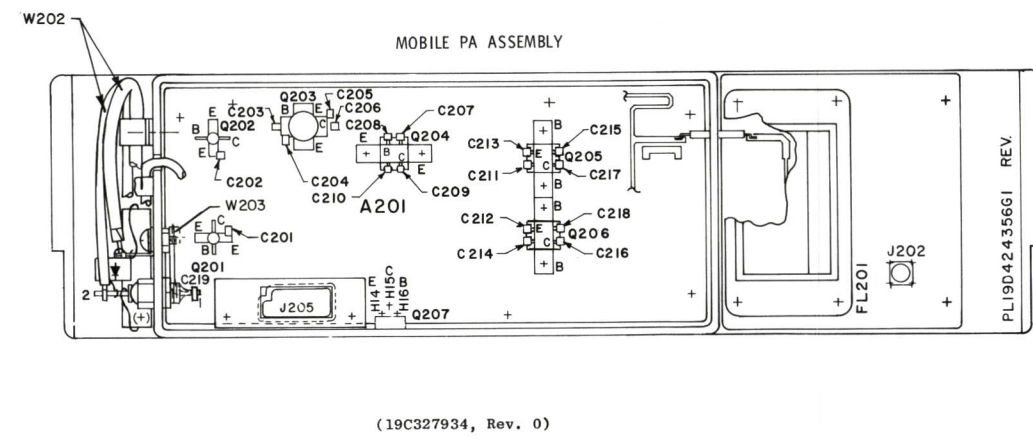
When the transmitter is keyed, rectified RF from CR1 is applied to a transistorized switch in the Power Control IC (U1), turning on the switch. The switch operates a voltage regulator. The directional coupler senses the forward power at the output of the power amplifier and feeds voltage back to the Power Control IC, resulting in feedback control of the voltage regulator output. A constant voltage is fed via Pin 4 of U1 to Power Adjust potentiometer R24. The setting of R24 determines the voltage fed to the base and collector of Q201 and the collector of Q202. Reducing the supply voltage to these stages reduces the drive to the remaining stages of the power amplifier, thereby reducing the power output of the PA.

Overvoltage sensing of the supply voltage via Pin 11 of U1 shuts down the driver when this condition occurs, thus protecting the driver and PA stages. The feedback power control performs the function of power leveling of the amplifier output over a range of varying input conditions such as drive level, DC voltage and load variations.

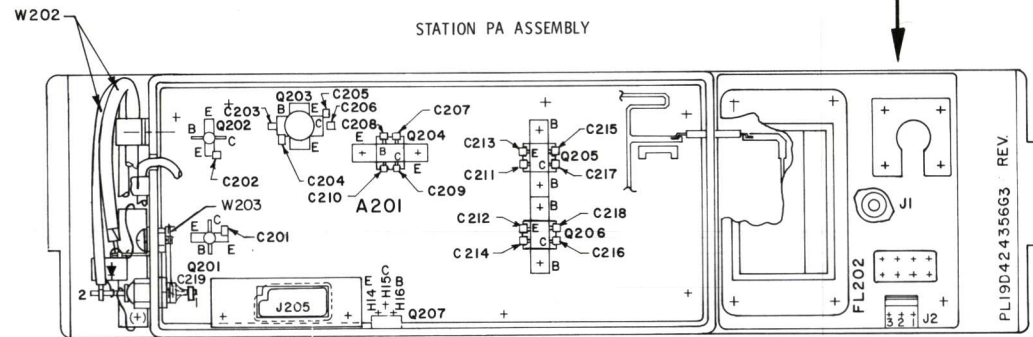
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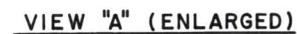




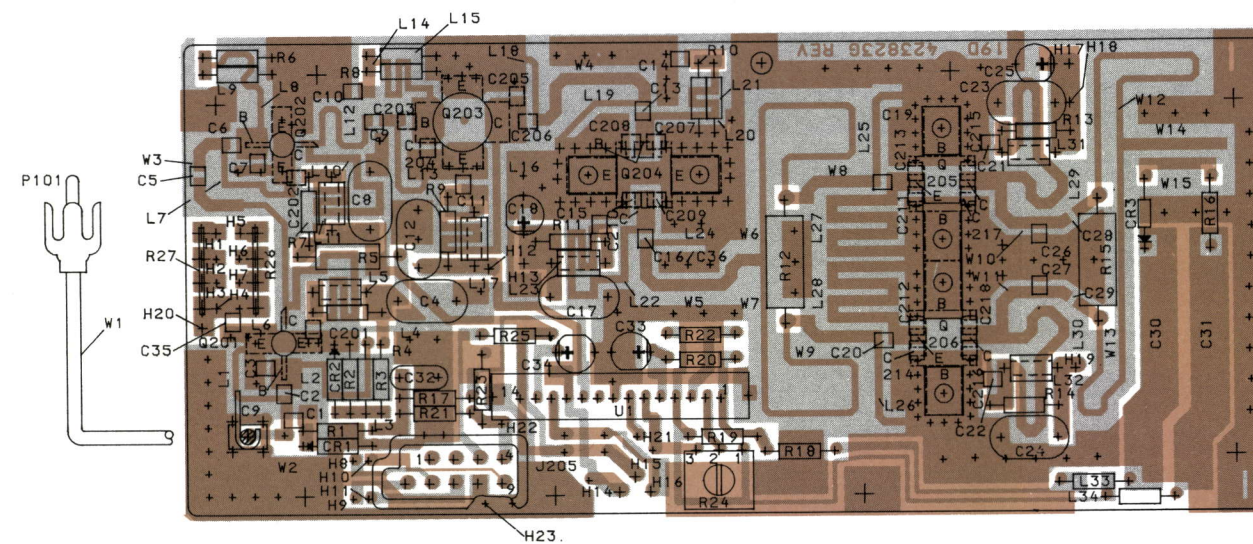
(19C327934, Rev. 0)



(19C327935, Rev. 0)



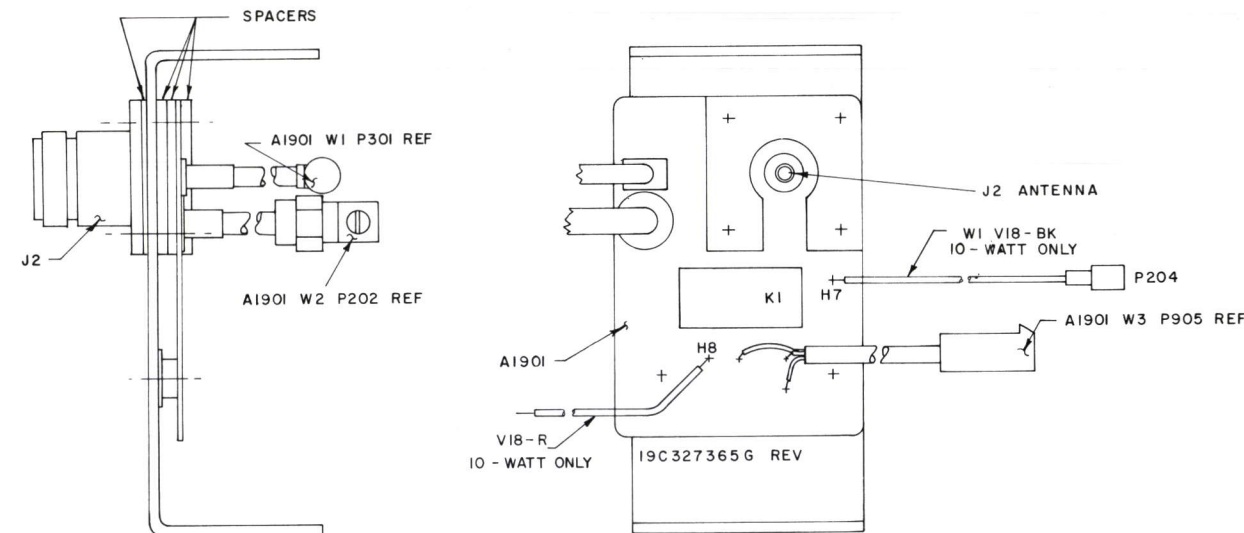
806—825 MHz, PA ASSEMBLY  
35-WATT MOBILE TRANSMITTER  
25-WATT STATION TRANSMITTER



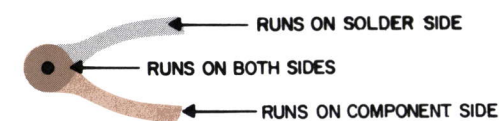
CONNECTIONS CHART		
FROM	TO	USING
H1	H17	W18
H2	H9	ST22-BR
H3	H8	ST22-R
H4	H12	W17
H5	H13	W20
H6	H10	ST22-G
H7	H11	ST22-W
H18	H19	W19

(19D424590, Rev. 4)  
(19B227301, Sh. 1, Rev. 1)  
(19B227301, Sh. 2, Rev. 1)

## ANTENNA RELAY ASSEMBLY



(19C327924, Rev. 1)



(19C327595, Rev. 0)  
(19B227304, Sh. 1, Rev. 0)  
(19B227304, Sh. 2, Rev. 0)

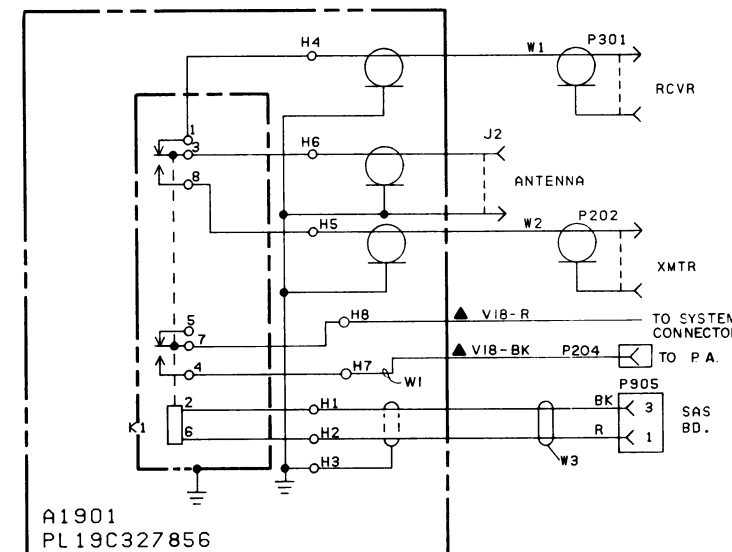
(19C327521, Rev. 0)  
(19B227657, Sh. 1, Rev. 1)  
(19B227657, Sh. 2, Rev. 0)

CONNECTION CHART			
FROM	TO	WIRE	REMARKS
H1	LET HANG	W3-BK	
H2	↑	W3-R	
H3		W3-SHLD	
H4	↓	W1	
H5	LET HANG	W2	

(19C327489, Rev. 1)  
(19B227558, Sh. 1, Rev. 1)  
(19B227558, Sh. 2, Rev. 0)



## ANTENNA RELAY (MOBILE)



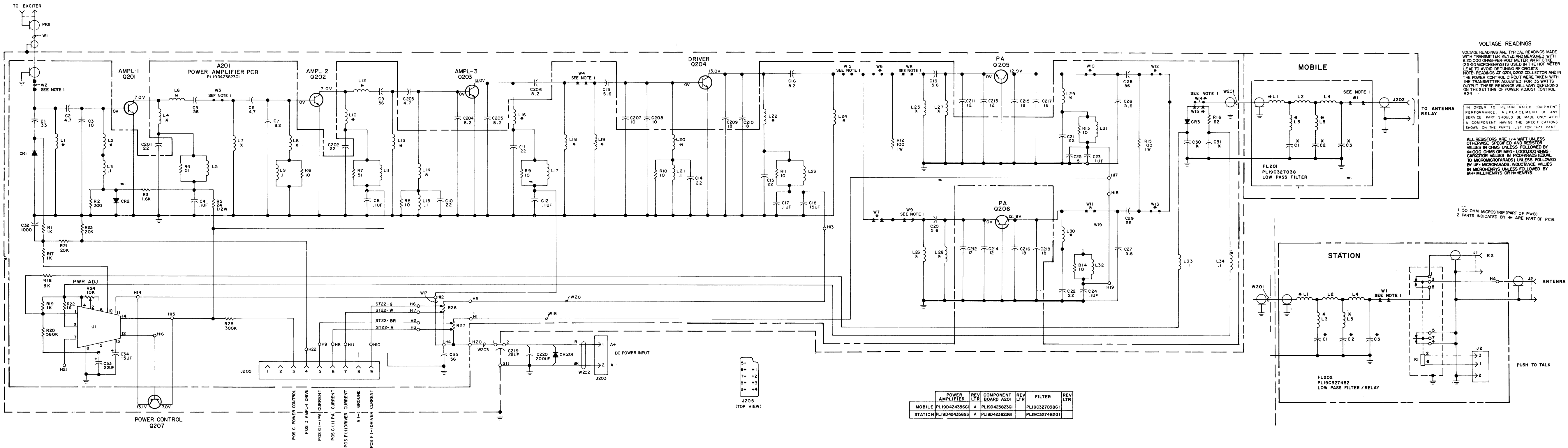
NOTES:  
1. ▲ THESE WIRES ARE PART OF 19C327365G2 ONLY

SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DESCRIPTION OF CHANGES UNDER EACH REVISION LETTER.

THIS ELEM DIAG APPLIES TO

MODEL NO	REV LETTER
PL19C327365G1	
PL19C327365G2	
PL19C327856G1	

(19B227557, Rev. 2)



### VOLTAGE READINGS

VOLTAGE READINGS ARE TYPICAL READINGS MADE WITH TRANSMITTER KEYED, AND MEASURED WITH A 20,000 OHMS-PER-VOLT METER. AN RF COKE (25-50MICROHENRYS) IS USED IN THE HOT METER LEAD TO AVOID DETUNING RF CIRCUITS.

NOTE: READINGS AT Q201, Q202 COLLECTOR AND IN THE POWER CONTROL CIRCUIT WERE TAKEN WITH THE TRANSMITTER ADJUSTED FOR 35 WATTS OUTPUT. THESE READINGS WILL VARY DEPENDING ON THE SETTING OF POWER ADJUST CONTROL

9.74

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG=1,000,000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF= MICROFARADS, INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

50 OHM MICROSTRIP (PART OF PWB)  
PARTS INDICATED BY \* ARE PART OF PCB.

### SCHEMATIC DIAGRAM

806—825 MHz, PA ASSEMBLY  
35-WATT MOBILE TRANSMITTER  
25-WATT STATION TRANSMITTER

PARTS LIST LBI30470E			SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
806-625 Mhz, PA ASSEMBLY 19D424356G1 MOBILE 19D424356G3 STATION 19D424356G5 MOBILE SYNTHESIZED 19D424356G6 STATION SYNTHESIZED																	
SYMBOL	GE PART NO.	DESCRIPTION															
A201		POWER AMPLIFIER BOARD 19D423823G1															
		----- CAPACITORS -----															
C1	19A134419P1	Ceramic: 3.3 pf ±.25 pf, 50 VDCW.	L1 and L2		----- INDUCTORS ----- (Part of 19D423824P1 printed board).	R25	3R152P304J	Composition: 300K ohms ±5%, 1/4 w.	J2	7777145P5	Connector, plug: 1 female contact; sim to Amphenol 82-97 or Military UG-58A/U. (STATION).						
C2	19A134419P5	Ceramic: 4.7 pf ±.25 pf, 50 VDCW.	L3	19B209420P101	Coil, RF: 0.10 µh ±10%, 0.08 ohms DC res max; sim to Jeffers 4416-1K.	R26 and R27	19C320212P2	Shunt resistor.	J202		(Part of FL201).						
C3	19A134419P13	Ceramic: 10 pf ±5% pf, 50 VDCW.	L4	19A129773G1	(Part of 19D423824P1 printed board).	U1	19D429709G4	Power Control.			----- PLUGS ----- (Part of W202).						
C4	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	L5		Coil.			----- CABLES -----	P101		----- TRANSISTORS -----						
C5	19A134419P31	Ceramic: 56 pf ±5% pf, 50 VDCW.	L6 thru L8		(Part of 19D423824P1 printed board).	W1	19A136858G1	Cable. Includes (P101).	Q201	19A134430P1	Silicon, NPN.						
C6	19A134419P5	Ceramic: 4.7 pf ±.25 pf, 50 VDCW.	L9	19B209420P101	Coil, RF: 0.10 µh ±10%, 0.08 ohms DC res max; sim to Jeffers 4416-1K.	W2 thru W15		(Part of 19D424824P1 printed board).	Q202	19A134430P2	Silicon, NPN.						
C7	19A134419P11	Ceramic: 8.2 pf ±5% pf, 50 VDCW.	L10		(Part of 19D423824P1 printed board).	W17	19B227659P4	Jumper.	Q203	19A134431P1	Silicon, NPN.						
C8	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	L11	19A129773G1	Coil.	W18	19B227659P2	Jumper.	Q204	19A134432P1	Silicon, NPN.						
C9	19A134419P31	Ceramic: 56 pf ±5% pf, 50 VDCW.	L12 thru L14		(Part of 19D423824P1 printed board).	W19	19B227659P1	Jumper.	Q205 and Q206	19A134433P1	Silicon, NPN.						
C10 and C11	19A134419P21	Ceramic: 22 pf ±5% pf, 50 VDCW.	L15	19B209420P101	Coil, RF: 0.10 µh ±10%, 0.08 ohms DC res max; sim to Jeffers 4416-1K.	W20	19B227659P3	Jumper.	Q207	19A116942P1	Silicon, PNP.						
C12	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	L16		(Part of 19D423824P1 printed board).			----- CAPACITORS -----			----- CABLES -----						
C13	19A134419P7	Ceramic: 5.6 pf ±5% pf, 50 VDCW.	L17	19A129773G1	Coil.	C201 and C202	19A134419P21	Ceramic: 22 pf ±5% pf, 50 VDCW.	W201	19A136858G1	Cable, RF.						
C14 and C15	19A134419P21	Ceramic: 22 pf ±5% pf, 50 VDCW.	L18 thru L20		(Part of 19D423824P1 printed board).	C203	19A134419P5	Ceramic: 4.7 pf ±.25 pf, 50 VDCW.	W202A	19B227058G1	Cable: approx 1 foot long.						
			L21	19B209420P101	Coil, RF: 0.10 µh ±10%, 0.08 ohms DC res max; sim to Jeffers 4416-1K.	C204 thru C206	19A134419P11	Ceramic: 8.2 pf ±5% pf, 50 VDCW.	W202B	19B227058G2	Cable: approx 1 foot long.						
			L22		(Part of 19D423824P1 printed board).	C207 and C208	19A134419P13	Ceramic: 10 pf ±5% pf, 50 VDCW.	W203	19B227659P5	Jumper.						
			L23	19A129773G1	Coil.	C209 and C210	19A134418P19	Ceramic: 18 pf ±5% pf, 50 VDCW.			ASSOCIATED ASSEMBLIES						
			L24 thru L30		(Part of 19D423824P1 printed board).	C211 thru C214	19A134419P15	Ceramic: 12 pf ±5% pf, 50 VDCW.			MOBILE ANTENNA RELAY 19C327385G1						
											COMPONENT BOARD 19C327856G1						
			L31 and L32	19A129773G1	Coil.	C215 thru C218	19A134418P19	Ceramic: 18 pf ±5% pf, 50 VDCW.	A1901		----- RELAYS -----						
C16	19A134418P11	Ceramic: 8.2 pf ±5% pf, 50 VDCW.	L33 and L34	19B209420P101	Coil, RF: 0.10 µh ±10%, 0.08 ohms DC res max; sim to Jeffers 4416-1K.	C219	19A116708P1	Ceramic, feed-thru: 0.01 µf +100% -0%, 500 VDCW; sim to Erie 327050X-SW0103P.	K1	19A700061P1	Hermetic sealed: 180-341 ohms coil res, 8-16.3 VDC; sim to GE 38AV1760A2, CP Clare HPW-1201558, or Potter-Brumfield HCM6160.						
C17	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.			----- PLUGS ----- (Part of W1).	C220*	19A115680P10	Electrolytic: 200 µf +150% -10%, 18 VDCW; sim to Mallory Type TTX.			----- PLUGS -----						
C18	19A134202P8	Tantalum: 15 µf ±20%, 20 VDCW.	P101		----- RESISTORS -----		19A115680P5	Earlier than REV A: Electrolytic: 100 µf +150% -10%, 25 VDCW; sim to Mallory Type TTX.	P202		(Part of W2).						
C19 and C20	19A134419P7	Ceramic: 5.6 pf ±5% pf, 50 VDCW.						----- DIODES AND RECTIFIERS -----	P301		(Part of W1).						
C21 and C22	19A134418P21	Ceramic: 22 pf ±5% pf, 50 VDCW.						Rectifier, silicon: 100 VDC blocking, 6 amps.	P905		(Part of W3).						
C23 and C24	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.						----- FILTERS -----			----- CABLES -----						
C25	19A134202P8	Tantalum: 15 µf ±20%, 20 VDCW.						Lowpass Filter. (MOBILE).	W1	19A136861G1	Cable, RF: approx 5-1/2 inches long. Includes (P301) 7104941P21.						
C26 and C27	19A134418P7	Ceramic: 5.6 pf ±5% pf, 50 VDCW.							W2	19B227567G1	Cable, RF: approx 14-1/4 inches long. Includes (P202) 19A134413P4.						
C28 and C29	19A134418P31	Ceramic: 56 pf ±5% pf, 50 VDCW.							W3	19A136804G1	Cable: approx 22 inches long. Includes (P905) 19A116559P14.						
C30 and C31		(Part of 19D423824P1 printed board).									----- JACKS AND RECEPTACLES -----						
C32	19A116855P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.							J1	19A130924G1	Receptacle, coaxial: jack type; sim to Cinch 14H11613.						
C33	19A134202P8	Tantalum: 22 µf ±20%, 15 VDCW.							J2	19A116659P55	Connector, printed wiring: 3 contacts; sim to Molex 09-05-1031.						
C34	19A134202P8	Tantalum: 15 µf ±20%, 20 VDCW.									----- MISCELLANEOUS -----						
C35	19A134419P31	Ceramic: 56 pf ±5% pf, 50 VDCW.									PA Cover.						
		----- DIODES AND RECTIFIERS -----							K1	19A700061P1	Hermetic sealed: 180-341 ohms coil res, 8-16.3 VDC; sim to GE 38AV1760A2, CP Clare HPW-1201558, or Potter-Brumfield HCM6160.						
CR1	19A116052P1	Silicon, hot carrier: Fwd. drop .350 volts max.									Support. (J2).						
CR2	19A115775P1	Silicon.									Spacer. (MOBILE- Quantity 3- Used with Antenna Relay).						
CR3	19A116052P2	Silicon, hot carrier: Fwd. drop .410 volts max.									Spacer. (MOBILE- Quantity 1- Used with Antenna Relay).						
		----- JACKS AND RECEPTACLES -----							L2	19A136863P1	Coil.						
									L4	19A136863P1	Coil.						
J205	19B219374G1	Connector: 9 contacts.									19B227679P2	Spacer. (STATION- TOP - Used with antenna relay jack J2).					
											19B227679P1						

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

ADDENDUM TO LBI30469E

This addendum describes Revision Letter changes that are not yet included in the publication.

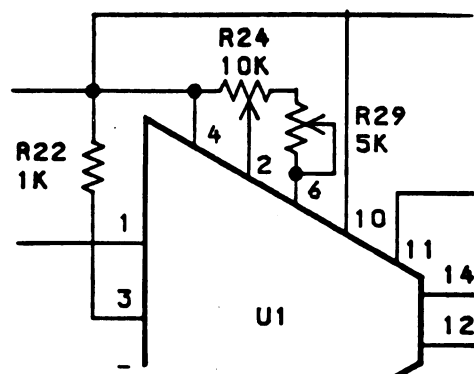
REV.A- 19D423823G1-3 POWER AMPLIFIER BOARD.

TO REDUCE THE PROBABILITY OF P.A. BURN-UP DUE TO MISADJUSTMENT FO EXCESSIVE POWER. ADDED R29. PART NUMBER FOR R29 IS 19A700016P3. VARAIBLE RESISTOR, 5000 OHMS + OR - 10%, 1/2 WATT.

ADJUSTMENT PROCEDURE

1. TURN POWER ADJUST CONTROL R24 AND POWER LIMIT CONTROL R29 FULLY CLOCKWISE. NOTE THAT POWER OUTPUT EXCEEDS RATED POWER OUTPUT FOR ALL CHANNELS.
2. SET LIMIT CONTROL TO PROVIDE A POWER OUTPUT 1 DB GREATER THAN RATED POWER.

NEW SCHEMATIC IS



NOTE: THE NEW PRINTED WIRE PATTERN IS INCORPORATED IN THIS CHANGE.